

STD888

HIGH CURRENT, HIGH PERFORMANCE, LOW VOLTAGE PNP TRANSISTOR

Ordering Code	Marking		
STD888	D888		

- VERY LOW COLLECTOR TO EMITTER SATURATION VOLTAGE
- DC CURRENT GAIN, h_{FE} > 100
- 5 A CONTINUOUS COLLECTOR CURRENT
- SURFACE-MOUNTING DPAK (TO-252)
- POWER PACKAGE IN TAPE & REEL (Suffix "T4")

APPLICATIONS

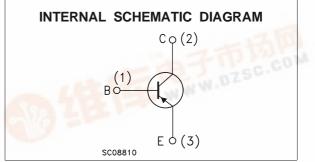
- POWER MANAGEMENT IN PORTABLE EQUIPMENT
- VOLTAGE REGULATION IN BIAS SUPPLY CIRCUITS
- SWITCHING REGULATOR IN BATTERY CHARGER APPLICATIONS
- HEAVY LOAD DRIVER

DESCRIPTION

The device is manufactured in low voltage PNP Planar Technology by using a "Base Island" layout.

The resulting Transistor shows exceptional high gain performance coupled with very low saturation voltage.





ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
Vсво	Collector-Base Voltage (I _E = 0)	-60	V
Vceo	Collector-Emitter Voltage (I _B = 0)	-30	V
Vebo	Emitter-Base Voltage (Ic = 0)	-6	V
lc	Collector Current	-5	А
Ісм	Collector Peak Current (t _p < 5 ms)	-10	А
Ptot	Total Dissipation at $T_{C} = 25 \ ^{\circ}C$	15	W
T _{stg}	Storage Temperature	-65 to 150	°C
Tj	Max. Operating Junction Temperature	150	°C



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THERMAL DATA

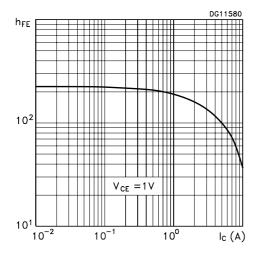
R _{thi-case} •	Thermal Resistance Junction-Case	Max	8.33	°C/W	

ELECTRICAL CHARACTERISTICS ($T_{case} = 25 \,^{\circ}C$ unless otherwise specified)

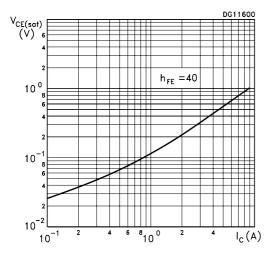
Symbol	Parameter Test Conditions		Min.	Тур.	Max.	Unit	
I _{CBO}	Collector Cut-off Current (I _E = 0)	V _{CB} = -30 V V _{CB} = -30 V	T _j = 100 °C			-10 -1	nΑ μΑ
I _{EBO}	Emitter Cut-off Current $(I_C = 0)$	V _{EB} = -6 V				-10	nA
V _{(BR)CEO*}	Collector-Emitter Breakdown Voltage (I _B = 0)	I _C = -10 mA		-30			V
V _{(BR)CBO}	Collector-Base Breakdown Voltage (I _E = 0)	I _C = -100 μA		-60			V
V _{(BR)EBO}	Emitter-Base Breakdown Voltage (I _C = 0)	I _E = -100 μA		-6			V
V _{CE(sat)} *	Collector-Emitter Saturation Voltage	$I_{C} = -500 \text{ mA}$ $I_{C} = -2 \text{ A}$ $I_{C} = -5 \text{ A}$ $I_{C} = -6 \text{ A}$ $I_{C} = -8 \text{ A}$ $I_{C} = -10 \text{ A}$	I _B = -5 mA I _B = -50 mA I _B = -250 mA I _B = -250 mA I _B = -400 mA I _B = -500 mA			-0.15 -0.25 -0.70 -0.70 -1 -1.5	V V V V V
$V_{BE(sat)}*$	Base-Emitter Saturation Voltage	$I_{C} = -2 A$ $I_{C} = -6 A$	I _B = -50 mA I _B = -250 mA			-1.1 -1.4	> >
h _{FE} *	DC Current Gain	$I_{C} = -10 \text{ mA}$ $I_{C} = -500 \text{ mA}$ $I_{C} = -5 \text{ A}$ $I_{C} = -5 \text{ A}$ $T_{j} = 100^{\circ}\text{C}$ $I_{C} = -8 \text{ A}$ $I_{C} = -10 \text{ A}$	$V_{CE} = -1 V$ $V_{CE} = -1 V$ $V_{CE} = -1 V$ $V_{CE} = -1 V$ $V_{CE} = -1 V$	150 150 75 75 40 15	200 200 100 100 55 35	300	
t _d tr ts t _f	RESISTIVE LOAD Delay Time RiseTime StorageTime Fall Time	$I_{C} = -3 A \qquad I_{B1}$ $V_{CC} = -20 V$			180 160 250 80	220 210 300 100	ns ns ns ns

* Pulsed: Pulse duration = 300 $\mu s,$ duty cycle \leq 1.5 %

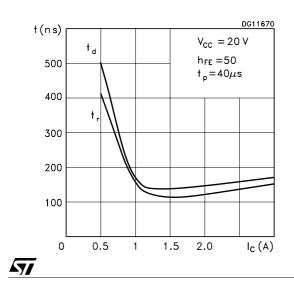
DC Current Gain



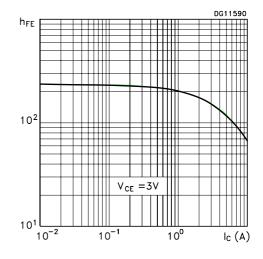
Collector-Emitter Saturation Voltage



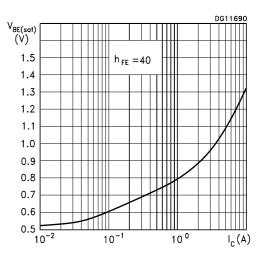
Switching Times Resistive Load



DC Current Gain



Base-Emitter Saturation Voltage



Switching Times Resistive Load

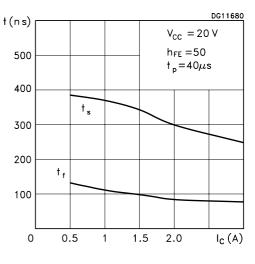
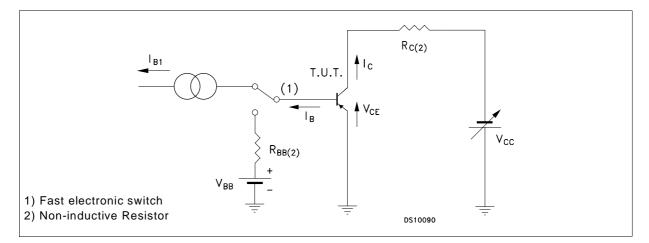


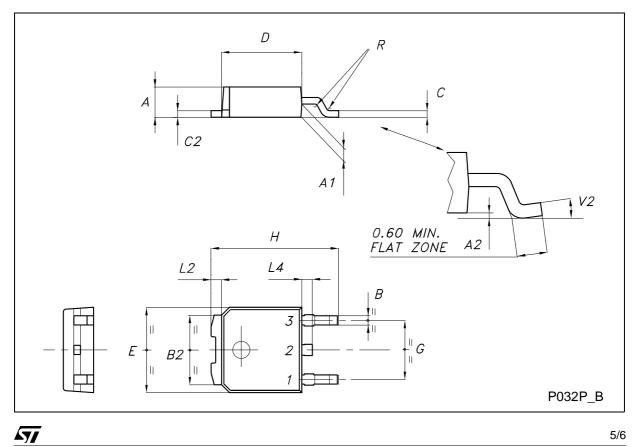
Figure 1: Resistive Load Switching Test Circuit.



57

DIM.	mm			inch			
Diwi.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.	
А	2.20		2.40	0.087		0.094	
A1	0.90		1.10	0.035		0.043	
A2	0.03		0.23	0.001		0.009	
В	0.64		0.90	0.025		0.035	
B2	5.20		5.40	0.204		0.213	
С	0.45		0.60	0.018		0.024	
C2	0.48		0.60	0.019		0.024	
D	6.00		6.20	0.236		0.244	
Е	6.40		6.60	0.252		0.260	
G	4.40		4.60	0.173		0.181	
Н	9.35		10.10	0.368		0.398	
L2		0.8			0.031		
L4	0.60		1.00	0.024		0.039	
V2	0°		8°	0°		0°	

TO-252 (DPAK) MECHANICAL DATA



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